Product data sheet

1. General description

High voltage, high speed NPN planar-passivated power switching transistor in a SOT78 plastic package intended for use in high frequency electronic lighting ballast applications

2. Features and benefits

- Fast switching
- High voltage capability of 700 V
- Low thermal resistance

3. Applications

· Electronic lighting ballasts

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values				Unit		
Absolute	Absolute maximum rating								
V_{CESM}	peak collector-emitter voltage	V _{BE} = 0 V 700				V			
I _c	collector current (DC)	DC; Fig. 1; Fig. 2; Fig. 4		4			А		
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C; <u>Fig. 3</u> 75				W			
Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Static ch	Static characteristics								
h _{FE} DC current gain		$I_C = 1 \text{ A}; V_{CE} = 5 \text{ V}; T_{mb} = 25 \text{ °C};$ Fig. 11		12	20	40			
		I_{C} = 2 A; V_{CE} = 5 V; T_{mb} = 25 °C; Fig. 11		10	17	28			

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	mb	С
2	С	collector		j
3	Е	emitter		В
mb	С	mounting base; connected to collector		E sym123

6. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
PHE13005	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78				

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{CESM}	peak collector-emitter voltage	V _{BE} = 0 V	700	V
V _{CBO}	collector-base voltage	I _E = 0 A	700	V
V _{CEO}	collector-emitter voltage	I _B = 0 A	400	V
Ic	collector current	DC; Fig. 1; Fig. 2; Fig. 4	4	А
I _{CM}	peak collector current		8	А
I _B	base current	DC	2	Α
I _{BM}	peak base current		4	Α
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C; <u>Fig. 3</u>	75	W
T _{stg}	storage temperature		-65 to 150	°C
T _j	junction temperature		150	°C
V _{EBO}	emitter-base voltage	I _C = 0 A	9	V

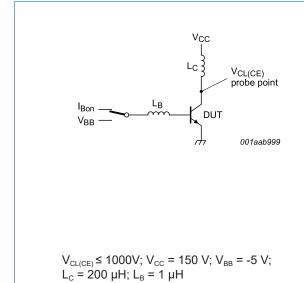


Fig. 1. Test circuit for reverse bias safe operating area

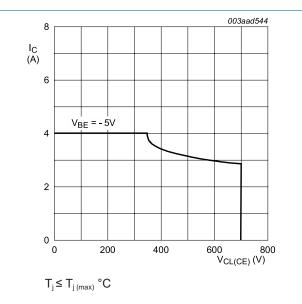


Fig. 2. Reverse bias safe operating area

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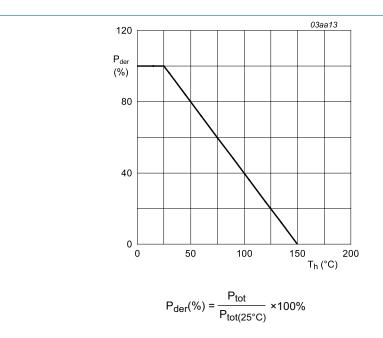
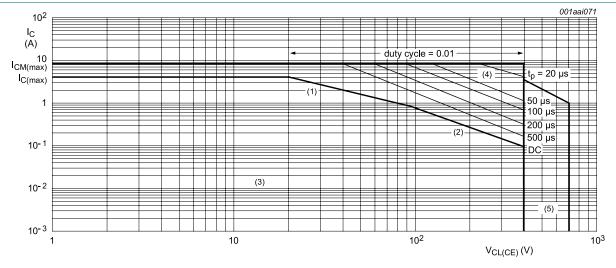


Fig. 3. Normalized total power dissipation as a function of heatsink temperature



 $T_h \le 25 \, ^{\circ}C$

Mounted with heatsink compound and (30 ± 5) N force on the centre of the envelope

- (1) P_{tot} maximum and P_{tot} peak maximum lines
- (2) Second breakdown limits
- (3) Region of permissible DC operation
- (4) Extension of operating region for repetitive pulse operation
- (5) Extension of operating region during turn-on in single transistor converters provided that $R_{BE} \le 100 \Omega$ and $t_p \le 0.6 \mu s$

Fig. 4. Forward bias safe operating area

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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 5	-	-	1.67	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W

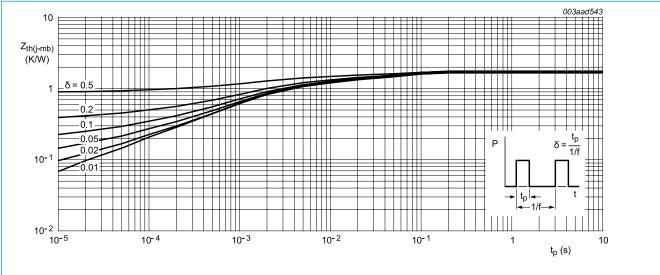


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

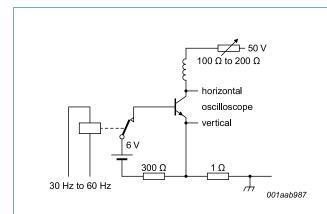
Silicon diffused power transistor

9. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I _{CES}	collector-emitter cut-off	$V_{BE} = -1.5 \text{ V}; V_{CE} = 700 \text{ V}; T_{mb} = 25 \text{ °C}$	-	-	1	mA
	current	V _{BE} = -1.5 V; V _{CE} = 700 V; T _j = 125 °C	-	-	5	mA
I _{CBO}	collector-base cut-off current	$V_{CB} = 700 \text{ V}; I_E = 0 \text{ A}; T_{mb} = 25 \text{ °C}$	-	-	1	mA
I _{CEO}	collector-emitter cut-off current	$V_{CEO} = 400 \text{ V}; I_{B} = 0 \text{ A}; T_{mb} = 25 \text{ °C}$	-	-	0.1	mA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 9 \text{ V; } I_{C} = 0 \text{ A; } T_{mb} = 25 \text{ °C}$	-	-	1	mA
V_{CEOsus}	collector-emitter sustaining voltage	$I_B = 0 \text{ A}; I_C = 10 \text{ mA}; L_C = 25 \text{ mH};$ $T_{mb} = 25 \text{ °C}; Fig. 6; Fig. 7$	400	-	-	V
V_{CEsat}	collector-emitter saturation voltage	I _C = 1.0 A; I _B = 0.2 A; T _{mb} = 25 °C; Fig. 8; Fig. 9	-	0.1	0.5	V
		I_{C} = 2.0 A; I_{B} = 0.5 A; T_{mb} = 25 °C; Fig. 8; Fig. 9	-	0.2	0.6	V
		I_{C} = 4.0 A; I_{B} = 1.0 A; T_{mb} = 25 °C; Fig. 8; Fig. 9	-	0.3	1	V
V_{BEsat}	base-emitter saturation voltage	$I_C = 1.0 \text{ A}; I_B = 0.2 \text{ A}; T_{mb} = 25 \text{ °C};$ Fig. 10	-	0.85	1.2	V
		$I_C = 2.0 \text{ A}; I_B = 0.5 \text{ A}; T_{mb} = 25 \text{ °C};$ Fig. 10	-	0.92	1.6	V
h _{FE}	DC current gain	I _C = 1 A; V _{CE} = 5 V; T _{mb} = 25 °C; Fig. 11	12	20	40	
		I _C = 2 A; V _{CE} = 5 V; T _{mb} = 25 °C; Fig. 11	10	17	28	
Dynamic	characteristics					
t _s	storage time	I_{C} = 2 A; I_{Bon} = 0.4 A; I_{Boff} = -0.4 A; R_{L} = 75 Ω ; T_{mb} = 25 °C; resistive load; Fig. 12; Fig. 13	-	2.7	4	μs
		I_{C} = 2 A; I_{Bon} = 0.4 A; V_{BB} = -5 V; L_{B} = 1 μ H; T_{mb} = 25 °C; inductive load; <u>Fig. 14</u> ; <u>Fig. 15</u>	-	1.2	2	μs
		I_{C} = 2 A; I_{Bon} = 0.4 A; V_{BB} = -5 V; L_{B} = 1 μ H; T_{mb} = 100 °C; inductive load; <u>Fig. 14</u> ; <u>Fig. 15</u>	-	1.4	4	μs
t _f	fall time	I_{C} = 2 A; I_{Bon} = 0.4 A; I_{Boff} = -0.4 A; R_{L} = 75 Ω ; T_{mb} = 25 °C; resistive load; Fig. 12; Fig. 13	-	0.3	0.9	μs
		I_{C} = 2 A; I_{Bon} = 0.4 A; V_{BB} = -5 V; L_{B} = 1 μ H; T_{mb} = 25 °C; inductive load; Fig. 14; Fig. 15	-	0.1	0.5	μs
		I _C = 2 A; I _{Bon} = 0.4 A; V _{BB} = -5 V; L _B = 1 μH; T _{mb} = 100 °C; inductive load; Fig. 14; Fig. 15	-	0.16	0.9	μs

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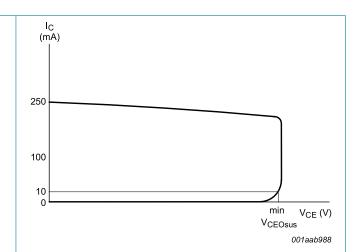
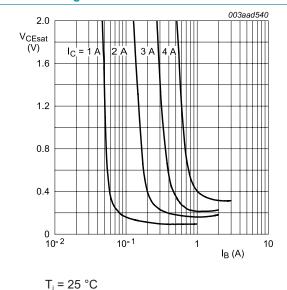


Fig. 6. Test circuit for collector-emitter sustaining voltage

Fig. 7. Oscilloscope display for collector-emitter sustaining voltage test waveform



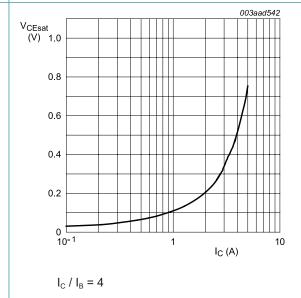


Fig. 8. Collector-emitter saturation voltage; typical values

Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values

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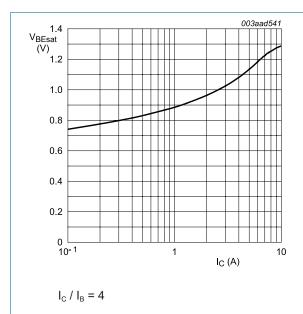
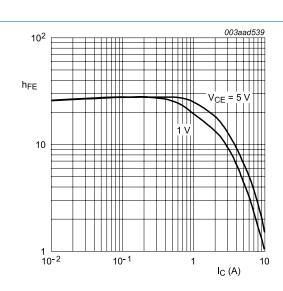
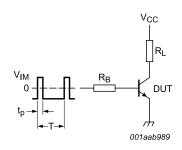


Fig. 10. Base-emitter saturation voltage; typical values



T_j = 25 °C Fig. 11. DC current gain as a function of collector current; typical values



 V_{IM} = - 6 to + 8 V; V_{CC} = 250 V; t_{p} = 20 $\mu s;$ δ = t_{p} / T = 0.01

 R_B and R_L calculated from I_{Con} and I_{Bon} requirements.



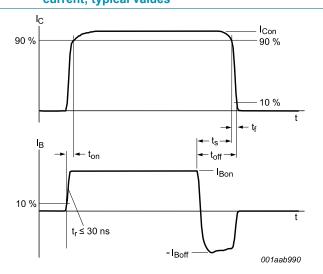
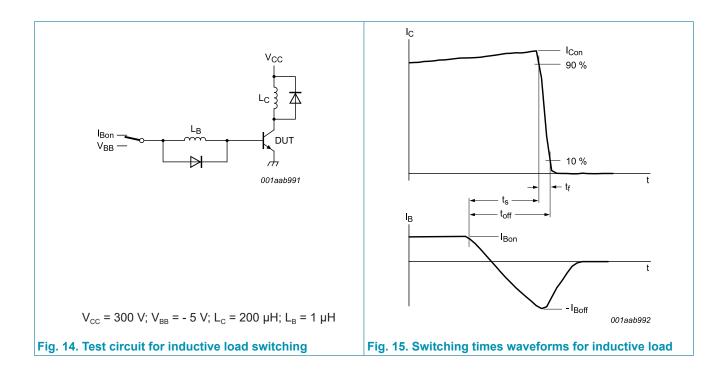


Fig. 13. Switching times waveforms for resistive load

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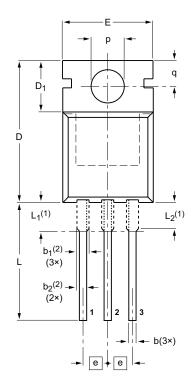


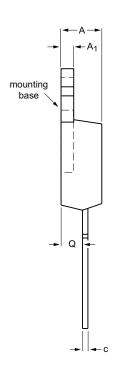
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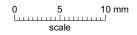
10. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78







DIMENSIONS (mm are the original dimensions)

UNIT	Α	A ₁	b	b ₁ ⁽²⁾	b ₂ ⁽²⁾	С	D	D ₁	E	е	L	L ₁ ⁽¹⁾	L ₂ ⁽¹⁾ max.	р	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

Notes

- 1. Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT78		3-lead TO-220AB	SC-46			08-04-23 08-06-13

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11. Legal information

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Document status [1][2]	Product status [3]	Definition		
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.		
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.		
Product [short] data sheet	Production	This document contains the product specification.		

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- [2] The term 'short data sheet' is explained in section "Definitions".
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